











SN74LVC2T45

SCES516K - DECEMBER 2003 - REVISED JUNE 2017

# SN74LVC2T45 Dual-Bit Dual-Supply Bus Transceiver With Configurable Voltage **Translation**

#### **Features**

- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- V<sub>CC</sub> Isolation Feature If Either V<sub>CC</sub> Input Is at GND, Both Ports Are in the High-Impedance State
- DIR Input Circuit Referenced to V<sub>CCA</sub>
- Low Power Consumption, 4-μA Max I<sub>CC</sub>
- Available in the Texas Instruments NanoFree™ Package
- ±24-mA Output Drive at 3.3 V
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Max Data Rates
  - 420 Mbps (3.3-V to 5-V Translation)
  - 210 Mbps (Translate to 3.3 V)
  - 140 Mbps (Translate to 2.5 V)
  - 75 Mbps (Translate to 1.8 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 4000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

# **Applications**

- Personal Electronic
- Industrial
- Enterprise
- Telecom

### 3 Description

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{\text{CCA}}.\ V_{\text{CCA}}$  accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track  $V_{\text{CCB}}.\ V_{\text{CCB}}$  accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

The SN74LVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess I<sub>CC</sub> and I<sub>CCZ</sub>.

The SN74LVC2T45 is designed so that the DIR input circuit is supplied by V<sub>CCA</sub>. This device is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

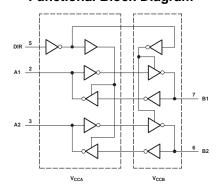
The V<sub>CC</sub> isolation feature ensures that if either V<sub>CC</sub> input is at GND, both ports are in the high-impedance state. NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

## **Device Information**(1)

| PART NUMBER    | PACKAGE   | BODY SIZE (NOM)   |
|----------------|-----------|-------------------|
| SN74LVC2T45DCT | SM8 (8)   | 2.95 mm x 2.80 mm |
| SN74LVC2T45DCU | VSSOP (8) | 2.30 mm x 2.00 mm |
| SN74LVC2T45YZP | DSBGA (8) | 1.89 mm x 0.89 mm |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

#### **Functional Block Diagram**





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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| С | changes from Revision J (October 2014) to Revision K  | Page |
|---|---|------|
| • | Changed data sheet title  | 1    |
| • | Added Junction temperature, T <sub>J</sub> in <i>Absolute Maximum Ratings</i>   | 4    |
| • | Added Documentation Support, Receiving Notification of Documentation Updates and Community Resources  | 19   |
| С | changes from Revision I (March 2007) to Revision J  | Page |
| • | Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functiona Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device | I    |

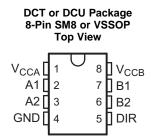
and Documentation Support section, and Mechanical, Packaging, and Orderable Information section ......1

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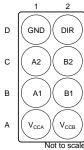
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# 5 Pin Configuration and Functions







Pin Functions: DCT, DCU

|     | PIN              | TVDE | DECODINE   |
|-----|------------------|------|--|
| NO. | NAME             | TYPE | DESCRIPTION  |
| 1   | V <sub>CCA</sub> | Р    | A-port supply voltage. 1.65 V ≤ V <sub>CCA</sub> ≤ 5.5 V |
| 2   | A1               | I/O  | Input/output A1. Referenced to V <sub>CCA</sub>          |
| 3   | A2               | I/O  | Input/output A2. Referenced to V <sub>CCA</sub>          |
| 4   | GND              | G    | Ground   |
| 5   | DIR              | I    | Direction control signal                                 |
| 6   | B2               | I/O  | Input/output B2. Referenced to V <sub>CCB</sub>          |
| 7   | B1               | I/O  | Input/output B1. Referenced to V <sub>CCB</sub>          |
| 8   | V <sub>CCB</sub> | Р    | B-port supply voltage. 1.65 V ≤ V <sub>CCB</sub> ≤ 5.5 V |

#### **Pin Functions: YZP**

|      | PIN              | TVDE | DECODINE   |
|------|------------------|------|--|
| BALL | NAME             | TYPE | DESCRIPTION  |
| A1   | V <sub>CCA</sub> | Р    | A-port supply voltage. 1.65 V ≤ V <sub>CCA</sub> ≤ 5.5 V |
| A2   | V <sub>CCB</sub> | Р    | B-port supply voltage. 1.65 V ≤ V <sub>CCB</sub> ≤ 5.5 V |
| B1   | A1               | I/O  | Input/output A1. Referenced to V <sub>CCA</sub>          |
| B2   | B1               | I/O  | Input/output B1. Referenced to V <sub>CCB</sub>          |
| C1   | A2               | I/O  | Input/output A2. Referenced to V <sub>CCA</sub>          |
| C2   | B2               | I/O  | Input/output B2. Referenced to V <sub>CCB</sub>          |
| D1   | GND              | G    | Ground   |
| D2   | DIR              | I    | Direction control signal                                 |



### **Specifications**

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |  |                    | MIN  | MAX                    | UNIT |
|------------------|--|--------------------|------|------------------------|------|
| V <sub>CCA</sub> | Supply voltage   |                    | -0.5 | 6.5                    | V    |
| VI               | Input voltage <sup>(2)</sup>   | -0.5               | 6.5  | V                      |      |
| Vo               | Voltage range applied to any output in the high-impe                 | -0.5               | 6.5  | V                      |      |
| V                | Voltage range applied to any output in the high or low state (2) (3) | A port             | -0.5 | V <sub>CCA</sub> + 0.5 | V    |
| Vo               | low state (2) (3)  | B port             | -0.5 | $V_{CCB} + 0.5$        | V    |
| I <sub>IK</sub>  | Input clamp current  | V <sub>I</sub> < 0 |      | -50                    | mA   |
| $I_{OK}$         | Output clamp current   | V <sub>O</sub> < 0 |      | <b>–</b> 50            | mA   |
| Io               | Continuous output current  |                    |      | ±50                    | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND                    |                    |      | ±100                   | mA   |
| $T_{J}$          | Junction temperature   |                    |      | 150                    | °C   |
| T <sub>stg</sub> | Storage temperature  | ·                  | -65  | 150                    | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

The value of V<sub>CC</sub> is provided in the recommended operating conditions table.

#### 6.2 ESD Ratings

|                    |                         |   | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
|                    |                         | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | ±4000 |      |
| V <sub>(ESD)</sub> | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | ±1000 | V    |
|                    |                         | Machine model (A115-A)  | ±200  |      |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

#### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted) (1) (2) (3)

|                 | -              | -                          | V <sub>CCI</sub> | V <sub>CCO</sub> | MIN                     | MAX                       | UNIT |
|-----------------|----------------|----------------------------|------------------|------------------|-------------------------|---------------------------|------|
| $V_{CCA}$       | Cupply voltage |                            |                  |                  | 1.65                    | 5.5                       | V    |
| $V_{CCB}$       | Supply voltage |                            |                  |                  | 1.65                    | 5.5                       | V    |
| .,              |                |                            | 1.65 V to 1.95 V |                  | V <sub>CCI</sub> × 0.65 |                           |      |
|                 | High-level     | Data inputs <sup>(4)</sup> | 2.3 V to 2.7 V   |                  | 1.7                     |                           | V    |
| V <sub>IH</sub> | input voltage  | age Data inputs            | 3 V to 3.6 V     |                  | 2                       |                           | V    |
|                 |                |                            | 4.5 V to 5.5 V   |                  | $V_{CCI} \times 0.7$    |                           |      |
|                 |                |                            | 1.65 V to 1.95 V |                  |                         | $V_{\rm CCI} \times 0.35$ |      |
| V               | Low-level      | 1)ata innute(4)            | 2.3 V to 2.7 V   |                  |                         | 0.7                       | V    |
| V <sub>IL</sub> | input voltage  |                            | 3 V to 3.6 V     |                  |                         | 8.0                       | V    |
|                 |                |                            | 4.5 V to 5.5 V   |                  |                         | $V_{CCI} \times 0.3$      |      |

 $V_{\text{CCI}}$  is the  $V_{\text{CC}}$  associated with the input port.

 $V_{\text{CCO}}$  is the  $V_{\text{CC}}$  associated with the output port.

For  $V_{CCI}$  values not specified in the data sheet,  $V_{IH}$  min =  $V_{CCI} \times 0.7$  V,  $V_{IL}$  max =  $V_{CCI} \times 0.3$  V. (4)

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JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. See *Implications of Slow or* Floating CMOS Inputs, SCBA004.



# **Recommended Operating Conditions (continued)**

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup> (2) (3)

|                 |                                    |  | V <sub>CCI</sub> | V <sub>cco</sub> | MIN                   | MAX                           | UNIT |
|-----------------|------------------------------------|--|------------------|------------------|-----------------------|-------------------------------|------|
|                 |                                    |  | 1.65 V to 1.95 V |                  | $V_{CCA} \times 0.65$ |                               |      |
| V               | High-level                         | DIR  | 2.3 V to 2.7 V   |                  | 1.7                   |                               | V    |
| $V_{IH}$        | input voltage                      | (referenced to V <sub>CCA</sub> ) <sup>(5)</sup> | 3 V to 3.6 V     |                  | 2                     |                               | V    |
|                 |                                    |  | 4.5 V to 5.5 V   |                  | $V_{CCA} \times 0.7$  |                               |      |
|                 |                                    |  | 1.65 V to 1.95 V |                  |                       | V <sub>CCA</sub> × 0.35       |      |
| V               | Low-level                          | DIR  | 2.3 V to 2.7 V   |                  |                       | 0.7                           | \/   |
| VIL             | input voltage                      | (referenced to V <sub>CCA</sub> ) <sup>(5)</sup> | 3 V to 3.6 V     |                  |                       | 0.8                           | V    |
|                 |                                    |  | 4.5 V to 5.5 V   |                  |                       | $V_{CCA} \times 0.3$          |      |
| VI              | Input voltage                      |  |                  |                  | 0                     | 5.5                           | V    |
| Vo              | Output voltage                     |  |                  |                  | 0                     | V <sub>cco</sub>              | V    |
|                 | High lovel output ourrest          |  |                  | 1.65 V to 1.95 V |                       | -4                            |      |
|                 |                                    |  |                  | 2.3 V to 2.7 V   |                       | -8                            | mA   |
| I <sub>OH</sub> | High-level output curre            | erit   |                  | 3 V to 3.6 V     |                       | -24                           | mA   |
|                 |                                    |  |                  | 4.5 V to 5.5 V   |                       | -32                           |      |
|                 |                                    |  |                  | 1.65 V to 1.95 V |                       | 4                             |      |
|                 | Low lovel output ourre             | n.t  |                  | 2.3 V to 2.7 V   |                       | 8                             | A    |
| l <sub>OL</sub> | Low-level output curre             | nı   |                  | 3 V to 3.6 V     |                       | 24                            | mA   |
|                 |                                    |  |                  | 4.5 V to 5.5 V   |                       | 32                            |      |
|                 |                                    |  | 1.65 V to 1.95 V |                  |                       | -4 -8 -24 -32 4 8 24 32 20 20 |      |
|                 |                                    | Data innuta                                      | 2.3 V to 2.7 V   |                  |                       | 20                            |      |
| Δt/Δν           | Input transition rise or fall rate | Data inputs                                      | 3 V to 3.6 V     |                  |                       | 10                            | ns/V |
|                 | or ian rate                        |  | 4.5 V to 5.5 V   |                  |                       | 5                             |      |
|                 |                                    | Control input                                    | 1.65 V to 5.5 V  |                  |                       | 5                             |      |
| T <sub>A</sub>  | Operating free-air tem             | perature   |                  |                  | -40                   | 85                            | °C   |

<sup>(5)</sup> For  $V_{CCI}$  values not specified in the data sheet,  $V_{IH}$  min =  $V_{CCA} \times 0.7$  V,  $V_{IL}$  max =  $V_{CCA} \times 0.3$  V.

#### 6.4 Thermal Information

|                      |  |                              | SN74LVC2T45 |       |      |  |  |  |
|----------------------|--|------------------------------|-------------|-------|------|--|--|--|
|                      | THERMAL METRIC <sup>(1)</sup>                | C <sup>(1)</sup> DCT DCU YZP |             |       |      |  |  |  |
|                      |  |                              | 8 PINS      |       |      |  |  |  |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance       | 184.0                        | 203.6       | 105.8 | °C/W |  |  |  |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance    | 114.7                        | 75.9        | 1.6   | °C/W |  |  |  |
| $R_{\theta JB}$      | Junction-to-board thermal resistance         | 96.4                         | 82.3        | 10.8  | °C/W |  |  |  |
| ΨЈТ                  | Junction-to-top characterization parameter   | 40.8                         | 7.2         | 3.1   | °C/W |  |  |  |
| ΨЈВ                  | Junction-to-board characterization parameter | 95.4                         | 81.9        | 10.8  | °C/W |  |  |  |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



## 6.5 Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

|   | METER   | TEST COMPLETO  | NC             | V                | V                | Т   | A = 25° | С   | -40°C to +8            | -40°C to +85°C |      |  |
|---|---|--|----------------|------------------|------------------|-----|---------|-----|------------------------|----------------|------|--|
| PARA  | METER   | TEST CONDITIO  | N5             | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | TYP     | MAX | MIN                    | MAX            | UNIT |  |
|   |   | $I_{OH} = -100 \mu A$  |                | 1.65 V to 4.5 V  | 1.65 V to 4.5 V  |     |         |     | V <sub>CCO</sub> - 0.1 |                |      |  |
| $V_{OH}$  |   | $I_{OH} = -4 \text{ mA}$   |                | 1.65 V           | 1.65 V           |     |         |     | 1.2                    |                |      |  |
| $V_{OH}$  |   | $I_{OH} = -8 \text{ mA}$ $V_I$   | $V_I = V_{IH}$ | 2.3 V            | 2.3 V            |     |         |     | 1.9                    |                | V    |  |
|   |   | I <sub>OH</sub> = -24 mA   |                | 3 V              | 3 V              |     |         |     | 2.4                    |                |      |  |
|   |   | I <sub>OH</sub> = -32 mA   |                | 4.5 V            | 4.5 V            |     |         |     | 3.8                    |                |      |  |
|   |   | I <sub>OL</sub> = 100 μA   |                | 1.65 V to 4.5 V  | 1.65 V to 4.5 V  |     |         |     |                        | 0.1            |      |  |
|   |   | I <sub>OL</sub> = 4 mA   |                | 1.65 V           | 1.65 V           |     |         |     |                        | 0.45           |      |  |
| V <sub>OL</sub>   |   | I <sub>OL</sub> = 8 mA V <sub>I</sub>  | $=V_{IL}$      | 2.3 V            | 2.3 V            |     |         |     |                        | 0.3            | V    |  |
| Voh  I  Vol  I  I  Vol  I  I  I  I  I  I  I  I  I  I  I  I  I | I <sub>OL</sub> = 24 mA   |  | 3 V            | 3 V              |                  |     |         |     | 0.55                   |                |      |  |
|   |   | I <sub>OL</sub> = 32 mA  |                | 4.5 V            | 4.5 V            |     |         |     |                        | 0.55           |      |  |
| II  | DIR   | $V_I = V_{CCA}$ or GND   |                | 1.65 V to 5.5 V  | 1.65 V to 5.5 V  |     |         | ±1  |                        | ±2             | μΑ   |  |
|   | A port  | ort $V_1$ or $V_2 = 0$ to 5.5 V  |                | 0 V              | 0 to 5.5 V       |     |         | ±1  |                        | ±2             |      |  |
| loff  | B port $V_1$ or $V_0 = 0$ to 5.5<br>A or B $V_0 = V_{000}$ or GND |  |                | 0 to 5.5 V       | 0 V              |     |         | ±1  |                        | ±2             | μΑ   |  |
| I <sub>OZ</sub>   |   | $V_O = V_{CCO}$ or GND   |                | 1.65 V to 5.5 V  | 1.65 V to 5.5 V  |     |         | ±1  |                        | ±2             | μΑ   |  |
|   | 1   |  |                | 1.65 V to 5.5 V  | 1.65 V to 5.5 V  |     |         |     |                        | 3              |      |  |
| I <sub>CCA</sub>  | $V_I = V_{CCI}$ or GND, $I_O = 0$                                 |  | 5 V            | 0 V              |                  |     |         |     | 2                      | μΑ             |      |  |
|   |   |  |                | 0 V              | 5 V              |     |         |     |                        | -2             |      |  |
|   |   |  |                | 1.65 V to 5.5 V  | 1.65 V to 5.5 V  |     |         |     |                        | 3              |      |  |
| $I_{CCB}$   |   | $V_I = V_{CCI}$ or GND, $I_O$  | = 0            | 5 V              | 0 V              |     |         |     |                        | -2             | μΑ   |  |
| I <sub>CCA</sub>  |   |  |                | 0 V              | 5 V              |     |         |     |                        | 2              |      |  |
|   |   | $V_I = V_{CCI}$ or GND, $I_O$  | = 0            | 1.65 V to 5.5 V  | 1.65 V to 5.5 V  |     |         |     |                        | 4              | μΑ   |  |
| Al  | A port  | One A port at V <sub>CCA</sub> – DIR at V <sub>CCA</sub> ,<br>B port = open  | 0.6 V,         | 2 V to 5 5 V     | 2 V to 5 5 V     |     |         |     |                        | 50             |      |  |
| ΔI <sub>CCA</sub>   | DIR   | DIR at $V_{CCA} - 0.6 \text{ V}$ , B port = open, A port at $V_{CCA}$ or GNE | )              | 3 V to 5.5 V     | 3 V to 5.5 V     |     |         |     |                        | 50             | μA   |  |
| Δl <sub>CCB</sub>   | B port  | One B port at V <sub>CCB</sub> – 0<br>DIR at GND, A port =                   |                | 3 V to 5.5 V     | 3 V to 5.5 V     |     |         |     |                        | 50             | μΑ   |  |
| Cı  | DIR   | $V_I = V_{CCA}$ or GND   |                | 3.3 V            | 3.3 V            |     | 2.5     |     |                        |                | pF   |  |
| C <sub>io</sub>   | A or B<br>port  | $V_O = V_{CCA/B}$ or GND   |                | 3.3 V            | 3.3 V            |     | 6       |     |                        |                | pF   |  |

 $<sup>\</sup>begin{array}{ll} \hbox{(1)} & V_{CCO} \mbox{ is the } V_{CC} \mbox{ associated with the output port.} \\ \hbox{(2)} & V_{CCI} \mbox{ is the } V_{CC} \mbox{ associated with the input port.} \\ \end{array}$ 

# 6.6 Switching Characteristics: $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.8 V ± 0.15 V (unless otherwise noted) (see Figure 17)

| PARAMETER        | FROM    | TO<br>(OUTPUT) | V <sub>CCB</sub> = ±0.15 |      | V <sub>CCB</sub> = ±0.2 |      | V <sub>CCB</sub> = ±0.3 |      | V <sub>CCB</sub> = ±0.5 |      | UNIT |
|------------------|---------|----------------|--------------------------|------|-------------------------|------|-------------------------|------|-------------------------|------|------|
|                  | (INPUT) | (001F01)       | MIN                      | MAX  | MIN                     | MAX  | MIN                     | MAX  | MIN                     | MAX  |      |
| t <sub>PLH</sub> | ۸       | В              | 3                        | 17.7 | 2.2                     | 10.3 | 1.7                     | 8.3  | 1.4                     | 7.2  | no   |
| t <sub>PHL</sub> | A       | ь              | 2.8                      | 14.3 | 2.2                     | 8.5  | 1.8                     | 7.1  | 1.7                     | 7    | ns   |
| t <sub>PLH</sub> |         | Δ.             | 3                        | 17.7 | 2.3                     | 16   | 2.1                     | 15.5 | 1.9                     | 15.1 |      |
| t <sub>PHL</sub> | В       | Α              | 2.8                      | 14.3 | 2.1                     | 12.9 | 2                       | 12.6 | 1.8                     | 12.2 | ns   |
| t <sub>PHZ</sub> | DIR     | ۸              | 10.6                     | 30.9 | 10.3                    | 30.5 | 10.5                    | 30.5 | 10.7                    | 29.3 |      |
| t <sub>PLZ</sub> |         | А              | 7.3                      | 19.7 | 7.5                     | 19.6 | 7.5                     | 19.5 | 7                       | 19.4 | ns   |



# Switching Characteristics: V<sub>CCA</sub> = 1.8 V ± 0.15 V (continued)

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (unless otherwise noted) (see Figure 17)

|                                 |             | •        | J .                         | COA  |                              | •    |                              |      | , ,                     |      | •    |    |
|---------------------------------|-------------|----------|-----------------------------|------|------------------------------|------|------------------------------|------|-------------------------|------|------|----|
| PARAMETER                       | AMETER FROM |          | V <sub>CCB</sub> =<br>±0.15 |      | V <sub>CCB</sub> = 1<br>±0.2 |      | V <sub>CCB</sub> = 3<br>±0.3 |      | V <sub>CCB</sub> = ±0.5 |      | UNIT |    |
|                                 | (INPUT)     | (OUTPUT) | MIN                         | MAX  | MIN                          | MAX  | MIN                          | MAX  | MIN                     | MAX  |      |    |
| t <sub>PHZ</sub>                | DIR         | В        | 10                          | 27.9 | 8.4                          | 14.9 | 6.5                          | 11.3 | 4.1                     | 8.6  | 20   |    |
| $t_{PLZ}$                       | DIK         | DIK      | ь                           | 6.5  | 19.5                         | 7.2  | 12.6                         | 4.3  | 9.7                     | 2.1  | 7.1  | ns |
| t <sub>PZH</sub> (1)            | DID         | ^        |                             | 37.2 |                              | 28.6 |                              | 25.2 |                         | 22.2 |      |    |
| t <sub>PZL</sub> <sup>(1)</sup> | DIR         | A        |                             | 42.2 |                              | 27.8 |                              | 23.9 |                         | 20.8 | ns   |    |
| t <sub>PZH</sub> (1)            | DIR         | В        |                             | 37.4 |                              | 29.9 |                              | 27.8 |                         | 26.6 |      |    |
| t <sub>PZL</sub> <sup>(1)</sup> |             | Ь        |                             | 45.2 |                              | 39   |                              | 37.6 |                         | 36.3 | ns   |    |

<sup>(1)</sup> The enable time is a calculated value, derived using the formula shown in the Enable Times section.

## 6.7 Switching Characteristics: $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 17)

| PARAMETER                       | FROM    |          |      | CCB = 1.8 V V <sub>CCB</sub> = 2.5 V<br>±0.15 V ±0.2 V |     | V <sub>CCB</sub> = 3<br>±0.3 |     | V <sub>CCB</sub> = 5 V<br>±0.5 V |     | UNIT |     |     |
|---------------------------------|---------|----------|------|--|-----|------------------------------|-----|----------------------------------|-----|------|-----|-----|
|                                 | (INPUT) | (OUTPUT) | MIN  | MAX  | MIN | MAX                          | MIN | MAX                              | MIN | MAX  |     |     |
| t <sub>PLH</sub>                | А       | В        | 2.3  | 16   | 1.5 | 8.5                          | 1.3 | 6.4                              | 1.1 | 5.1  |     |     |
| t <sub>PHL</sub>                | A       | Ь        | 2.1  | 12.9   | 1.4 | 7.5                          | 1.3 | 5.4                              | 0.9 | 4.6  | ns  |     |
| t <sub>PLH</sub>                | В       | А        | 2.2  | 10.3   | 1.5 | 8.5                          | 1.4 | 8                                | 1   | 7.5  | ns  |     |
| t <sub>PHL</sub>                | В       | Ь        | A    | 2.2  | 8.5 | 1.4                          | 7.5 | 1.3                              | 7   | 0.9  | 6.2 | 115 |
| t <sub>PHZ</sub>                | 0.0     | ^        | 6.6  | 17.1   | 7.1 | 16.8                         | 6.8 | 16.8                             | 5.2 | 16.5 | no  |     |
| t <sub>PLZ</sub>                | DIR     | Α        | 5.3  | 12.6   | 5.2 | 12.5                         | 4.9 | 12.3                             | 4.8 | 12.3 | ns  |     |
| t <sub>PHZ</sub>                | DIR     | В        | 10.7 | 27.9   | 8.1 | 13.9                         | 5.8 | 10.5                             | 3.5 | 7.6  | ns  |     |
| t <sub>PLZ</sub>                | DIK     | Ь        | 7.8  | 18.9   | 6.2 | 11.2                         | 3.6 | 8.9                              | 1.4 | 6.2  | 115 |     |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR     | ^        |      | 29.2   |     | 19.7                         |     | 16.9                             |     | 13.7 | no  |     |
| t <sub>PZL</sub> <sup>(1)</sup> | DIK     | Α        |      | 36.4   |     | 21.4                         |     | 17.5                             |     | 13.8 | ns  |     |
| t <sub>PZH</sub> (1)            | DID     | В        |      | 28.6   |     | 21                           |     | 18.7                             |     | 17.4 | 200 |     |
| t <sub>PZL</sub> <sup>(1)</sup> | DIR     | В        |      | 30   |     | 24.3                         |     | 22.2                             |     | 21.1 | ns  |     |

<sup>(1)</sup> The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.

# 6.8 Switching Characteristics: $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 17)

| PARAMETER                       | FROM    | -        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.8 V<br>±0.15 V |      | V <sub>CCB</sub> = 2.5 V<br>±0.2 V |      | V <sub>CCB</sub> = 3.3 V<br>±0.3 V |      | V <sub>CCB</sub> = 5 V<br>±0.5 V |    | UNIT |
|---------------------------------|---------|----------|-----------------|----------------|-------------------------------------|------|------------------------------------|------|------------------------------------|------|----------------------------------|----|------|
|                                 | (INFOT) | (001701) | MIN             | MAX            | MIN                                 | MAX  | MIN                                | MAX  | MIN                                | MAX  |                                  |    |      |
| t <sub>PLH</sub>                | Α       | В        | 2.1             | 15.5           | 1.4                                 | 8    | 0.7                                | 5.6  | 0.7                                | 4.4  |                                  |    |      |
| t <sub>PHL</sub>                | A       | Ь        | 2               | 12.6           | 1.3                                 | 7    | 0.8                                | 5    | 0.7                                | 4    | ns                               |    |      |
| t <sub>PLH</sub>                | В       | А        | 1.7             | 8.3            | 1.3                                 | 6.4  | 0.7                                | 5.8  | 0.6                                | 5.4  | no                               |    |      |
| t <sub>PHL</sub>                |         | ь        | A               | 1.8            | 7.1                                 | 1.3  | 5.4                                | 0.8  | 5                                  | 0.7  | 4.5                              | ns |      |
| t <sub>PHZ</sub>                | DIR     | A        | 5               | 10.9           | 5.1                                 | 10.8 | 5                                  | 10.8 | 5                                  | 10.4 | ns                               |    |      |
| t <sub>PLZ</sub>                | DIK     | A        | 3.4             | 8.4            | 3.7                                 | 8.4  | 3.9                                | 8.1  | 3.3                                | 7.8  | 115                              |    |      |
| t <sub>PHZ</sub>                | DID     | В        | 11.2            | 27.3           | 8                                   | 13.7 | 5.8                                | 10.4 | 2.9                                | 7.4  |                                  |    |      |
| t <sub>PLZ</sub>                | DIR     | Ь        | 9.4             | 17.7           | 5.6                                 | 11.3 | 4.3                                | 8.3  | 1                                  | 5.6  | ns                               |    |      |
| t <sub>PZH</sub> <sup>(1)</sup> | DIR     | ^        |                 | 26             |                                     | 17.7 |                                    | 14.1 |                                    | 11   | no                               |    |      |
| t <sub>PZL</sub> <sup>(1)</sup> |         | А        |                 | 34.4           |                                     | 19.1 |                                    | 15.4 |                                    | 11.9 | ns                               |    |      |

(1) The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.



# Switching Characteristics: $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (continued)

 $\underline{\text{over recommended operating free-air temperature range, V}_{\text{CCA}} = 3.3 \text{ V} \pm 0.3 \text{ V} \text{ (unless otherwise noted) (see Figure 17)}$ 

| PARAMETER                       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.8 V<br>±0.15 V | V <sub>CCB</sub> = 2.5 V<br>±0.2 V | V <sub>CCB</sub> = 3.3 V<br>±0.3 V | V <sub>CCB</sub> = 5 V<br>±0.5 V | UNIT |  |
|---------------------------------|-----------------|----------------|-------------------------------------|------------------------------------|------------------------------------|----------------------------------|------|--|
|                                 | (INPOT)         | (001201)       | MIN MAX                             | MIN MAX                            | MIN MAX                            | MIN MAX                          |      |  |
| t <sub>PZH</sub> (1)            | DID             | В              | 23.9                                | 16.4                               | 13.9                               | 12.2                             | 20   |  |
| t <sub>PZL</sub> <sup>(1)</sup> | DIR             | В              | 23.5                                | 17.8                               | 15.8                               | 14.4                             | ns   |  |

## 6.9 Switching Characteristics: $V_{CCA} = 5 V \pm 0.5 V$

over recommended operating free-air temperature range,  $V_{CCA} = 5 \text{ V} \pm 0.5 \text{ V}$  (unless otherwise noted) (see Figure 17)

| PARAMETER                       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1<br>±0.15 | 1.8 V | V <sub>CCB</sub> = ±0.2 | 2.5 V<br>V | V <sub>CCB</sub> = 3<br>±0.3 |      | V <sub>CCB</sub> = ±0.5 | 5 V<br>V | UNIT |
|---------------------------------|-----------------|----------------|-------------------------------|-------|-------------------------|------------|------------------------------|------|-------------------------|----------|------|
|                                 | (INPOT)         | (001701)       | MIN                           | MAX   | MIN                     | MAX        | MIN                          | MAX  | MIN                     | MAX      |      |
| t <sub>PLH</sub>                | А               | В              | 1.9                           | 15.1  | 1                       | 7.5        | 0.6                          | 5.4  | 0.5                     | 3.9      | no   |
| t <sub>PHL</sub>                | A               | ь              | 1.8                           | 12.2  | 0.9                     | 6.2        | 0.7                          | 4.5  | 0.5                     | 3.5      | ns   |
| t <sub>PLH</sub>                | В               | А              | 1.4                           | 7.2   | 1                       | 5.1        | 0.7                          | 4.4  | 0.5                     | 3.9      |      |
| t <sub>PHL</sub>                | В               | A              | 1.7                           | 7     | 0.9                     | 4.6        | 0.7                          | 4    | 0.5                     | 3.5      | ns   |
| t <sub>PHZ</sub>                | DIR             | А              | 2.9                           | 8.2   | 2.9                     | 7.9        | 2.8                          | 7.9  | 2.2                     | 7.8      | ns   |
| t <sub>PLZ</sub>                | DIK             | A              | 1.4                           | 6.9   | 1.3                     | 6.7        | 0.7                          | 6.7  | 0.7                     | 6.6      | 115  |
| t <sub>PHZ</sub>                | DIR             | В              | 11.2                          | 26.1  | 7.2                     | 13.9       | 5.8                          | 10.1 | 1.3                     | 7.3      |      |
| t <sub>PLZ</sub>                | אוט             | Ь              | 8.4                           | 16.9  | 5                       | 11         | 4                            | 7.7  | 1                       | 5.6      | ns   |
| t <sub>PZH</sub> <sup>(1)</sup> | DID             | А              |                               | 24.1  |                         | 16.1       |                              | 12.1 |                         | 9.5      |      |
| t <sub>PZL</sub> <sup>(1)</sup> | DIR             | A              |                               | 33.1  |                         | 18.5       |                              | 14.1 |                         | 10.8     | ns   |
| t <sub>PZH</sub> (1)            | DIR             | В              |                               | 22    |                         | 14.2       |                              | 12.1 |                         | 10.5     | 200  |
| t <sub>PZL</sub> <sup>(1)</sup> | DIK             | Б              |                               | 20.4  |                         | 14.1       |                              | 12.4 |                         | 11.3     | ns   |

<sup>(1)</sup> The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.

## 6.10 Operating Characteristics

 $T_A = 25^{\circ}C$ 

| F                               | PARAMETER                      | TEST<br>CONDITIONS                               | V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 5 V | UNIT |  |
|---------------------------------|--------------------------------|--|---|---|---|---|------|--|
| C <sub>pdA</sub> (1)            | A-port input,<br>B-port output | C <sub>L</sub> = 0 pF,<br>f = 10 MHz,            | 3   | 4   | 4   | 4   | pF   |  |
| O <sub>pd</sub> A \ /           | B-port input,<br>A-port output | $t_r = t_f = 1 \text{ ns}$                       | 18  | 19  | 20  | 21  | pr   |  |
| C (1)                           | A-port input,<br>B-port output | $C_L = 0 \text{ pF},$                            | 18  | 19  | 20  | 21  |      |  |
| C <sub>pdB</sub> <sup>(1)</sup> | B-port input,<br>A-port output | $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$ | 3   | 4   | 4   | 4   | pF   |  |

(1) Power dissipation capacitance per transceiver



#### 6.11 Typical Characteristics

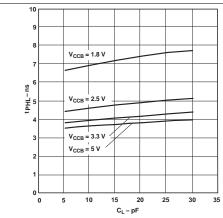


Figure 1. Typical Propagation Delay of High-to-Low (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.8 \text{ V}$ 

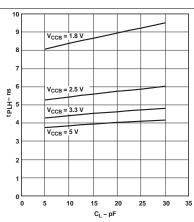


Figure 2. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.8 \text{ V}$ 

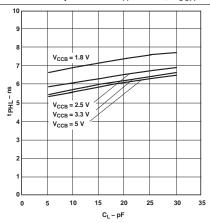


Figure 3. Typical Propagation Delay of High-to-Low (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.8 \text{ V}$ 

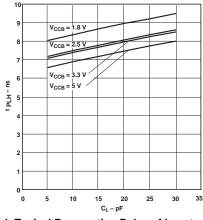


Figure 4. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.8 \text{ V}$ 

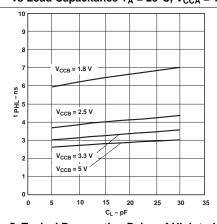


Figure 5. Typical Propagation Delay of High-to-Low (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 2.5 \text{ V}$ 

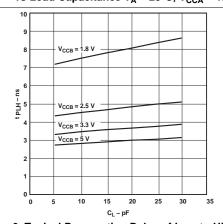


Figure 6. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 2.5$  V

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### **Typical Characteristics (continued)**

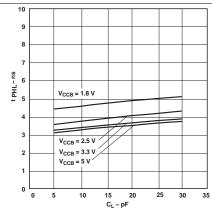


Figure 7. Typical Propagation Delay of High-to-Low (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 2.5$  V

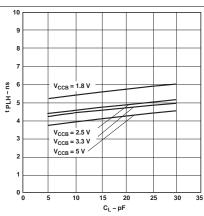


Figure 8. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 2.5$  V

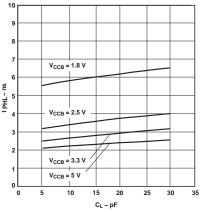


Figure 9. Typical Propagation Delay of High-to-Low (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 3.3 \text{ V}$ 

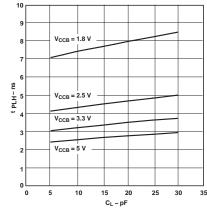


Figure 10. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 3.3 \text{ V}$ 

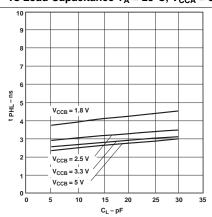


Figure 11. Typical Propagation Delay of High-to-Low (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 3.3 \text{ V}$ 

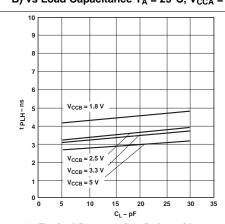


Figure 12. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 3.3 \text{ V}$ 

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#### **Typical Characteristics (continued)**

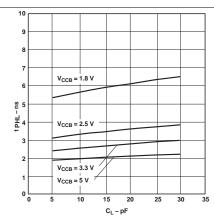


Figure 13. Typical Propagation Delay of High-to-Low (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 5 \text{ V}$ 

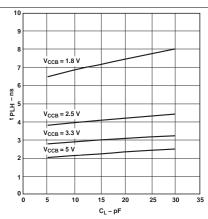


Figure 14. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 5 \text{ V}$ 

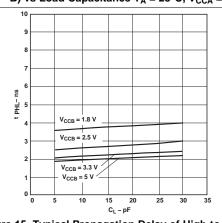


Figure 15. Typical Propagation Delay of High-to-Low (B to A) vs Load Capacitance  $T_A$  = 25°C,  $V_{CCA}$  = 5 V

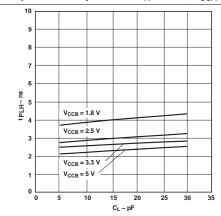


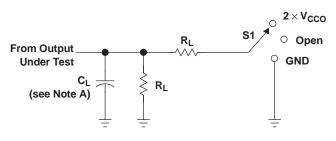
Figure 16. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 5$  V

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 $V_{\text{CCA}}$ 



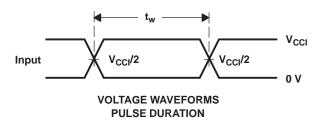
#### 7 Parameter Measurement Information



| TEST                               | S1                 |
|------------------------------------|--------------------|
| t <sub>pd</sub>                    | Open               |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | $2 \times V_{CCO}$ |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND                |

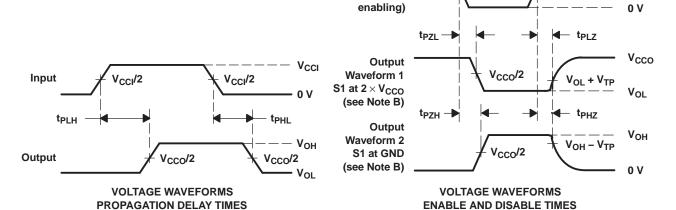
**LOAD CIRCUIT** 

| V <sub>CCO</sub>   | CL    | $R_{L}$      | V <sub>TP</sub> |
|--------------------|-------|--------------|-----------------|
| 1.8 V $\pm$ 0.15 V | 15 pF | <b>2 k</b> Ω | 0.15 V          |
| 2.5 V $\pm$ 0.2 V  | 15 pF | <b>2 k</b> Ω | 0.15 V          |
| 3.3 V $\pm$ 0.3 V  | 15 pF | <b>2 k</b> Ω | 0.3 V           |
| 5 V $\pm$ 0.5 V    | 15 pF | <b>2 k</b> Ω | 0.3 V           |



V<sub>CCA</sub>/2

V<sub>CCA</sub>/2



Output Control

(low-level

- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $dv/dt \geq$  1 V/ns.
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
  - I. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
  - J. All parameters and waveforms are not applicable to all devices.

Figure 17. Load Circuit and Voltage Waveforms

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#### 8 Detailed Description

#### 8.1 Overview

The SN74LVC2T45 is dual-bit, dual-supply noninverting voltage level translation. Pin Ax and direction control pin are support by  $V_{CCA}$  and pin Bx are support by  $V_{CCB}$ . The A port is able to accept I/O voltages ranging from 1.65 V to 5.5 V, while the B port can accept I/O voltages from 1.65 V to 5.5 V. The high on DIR allows data transmission from A to B and a low on DIR allows data transmission from B to A.

#### 8.2 Functional Block Diagram

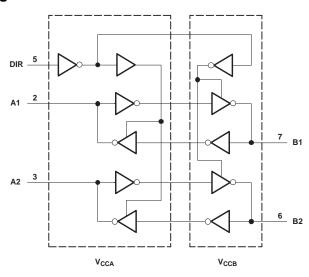


Figure 18. Logic Diagram (Positive Logic)

#### 8.3 Feature Description

# 8.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range

Both  $V_{CCA}$  and  $V_{CCB}$  can be supplied at any voltage between 1.65 V and 5.5 V making the device suitable for translating between any of the voltage nodes (1.8-V, 2.5-V, 3.3-V and 5-V).

#### 8.3.2 Support High-Speed Translation

SN74LVC2T45 can support high data rate application. The translated signal data rate can be up to 420 Mbps when signal is translated from 3.3 V to 5 V.

#### 8.3.3 I<sub>off</sub> Supports Partial-Power-Down Mode Operation

loff will prevent backflow current by disabling I/O output circuits when device is in partial-power-down mode.

#### 8.4 Device Functional Modes

Table 1 lists the functional modes of the SN74LVC2T45 device.

Table 1. Function Table<sup>(1)</sup> (Each Transceiver)

| INPUT<br>DIR | OPERATION       |
|--------------|-----------------|
| L            | B data to A bus |
| Н            | A data to B bus |

(1) Input circuits of the data I/Os always are active.



### 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The SN74LVC2T45 device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. The maximum data rate can be up to 420 Mbps when device translate signal from 3.3 V to 5 V.

#### 9.2 Typical Applications

## 9.2.1 Unidirectional Logic Level-Shifting Application

Figure 19 shows an example of the SN74LVC2T45 being used in a unidirectional logic level-shifting application.

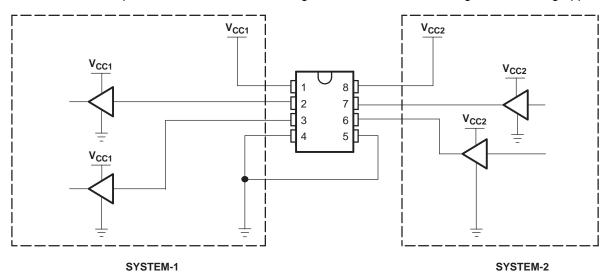


Figure 19. Unidirectional Logic Level-Shifting Application

#### 9.2.1.1 Design Requirements

Table 2 lists the pins and pin descriptions of the SN74LVC2T45 connections with SYSTEM-1 and SYSTEM-2.

Table 2. SN74LVC2T45 Pin Connections With SYSTEM-1 and SYSTEM-2

| PIN | NAME             | FUNCTION         | DESCRIPTION  |  |  |  |
|-----|------------------|------------------|--|--|--|--|
| 1   | V <sub>CCA</sub> | V <sub>CC1</sub> | SYSTEM-1 supply voltage (1.65 V to 5.5 V)                  |  |  |  |
| 2   | A1               | OUT1             | Output level depends on V <sub>CC1</sub> voltage.          |  |  |  |
| 3   | A2               | OUT2             | Output level depends on V <sub>CC1</sub> voltage.          |  |  |  |
| 4   | GND              | GND              | Device GND   |  |  |  |
| 5   | DIR              | DIR              | GND (low level) determines B-port to A-port direction.     |  |  |  |
| 6   | B2               | IN2              | Input threshold value depends on V <sub>CC2</sub> voltage. |  |  |  |
| 7   | B1               | IN1              | Input threshold value depends on V <sub>CC2</sub> voltage. |  |  |  |
| 8   | V <sub>CCB</sub> | V <sub>CC2</sub> | SYSTEM-2 supply voltage (1.65 V to 5.5 V)                  |  |  |  |



For this design example, use the parameters listed in Table 3.

**Table 3. Design Parameters** 

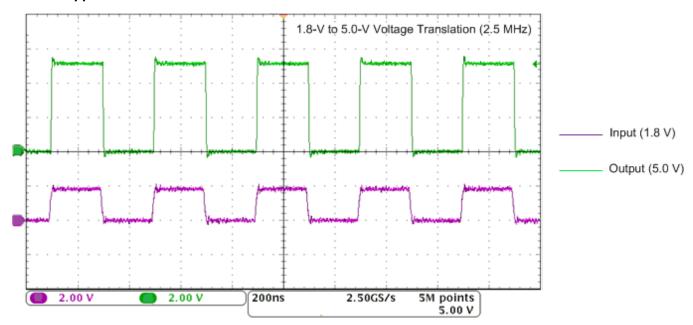
| DESIGN PARAMETER     | EXAMPLE VALUE   |
|----------------------|-----------------|
| Input voltage range  | 1.65 V to 5.5 V |
| Output voltage range | 1.65 V to 5.5 V |

#### 9.2.1.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the SN74LVC2T45 device to determine the input voltage range. For a valid logic high the value must exceed the  $V_{IH}$  of the input port. For a valid logic low the value must be less than the  $V_{IL}$  of the input port.
- Output voltage range
  - Use the supply voltage of the device that the SN74LVC2T45 device is driving to determine the output voltage range.

#### 9.2.1.3 Application Curve



#### 9.2.2 Bidirectional Logic Level-Shifting Application

Figure 20 shows the SN74LVC2T45 being used in a bidirectional logic level-shifting application. Because the SN74LVC2T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.

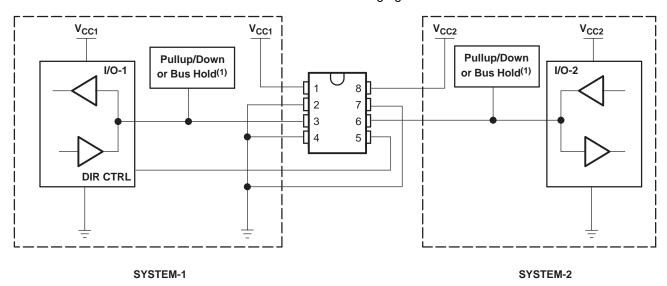


Figure 20. Bidirectional Logic Level-Shifting Application

#### 9.2.2.1 Design Requirements

Please refer to Unidirectional Logic Level-Shifting Application.

#### 9.2.2.2 Detailed Design Procedure

Table 4 shows data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

| STATE | DIR CTRL | I/O-1 | I/O-2 | DESCRIPTION  |
|-------|----------|-------|-------|--|
| 1     | Н        | Out   | In    | SYSTEM-1 data to SYSTEM-2  |
| 2     | Н        | Hi-Z  | Hi-Z  | SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The busline state depends on pullup or pulldown. (1) |
| 3     | L        | Hi-Z  | Hi-Z  | DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. (1)                          |
| 4     | L        | In    | Out   | SYSTEM-2 data to SYSTEM-1  |

**Table 4. Data Transmission Sequence** 

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, that is, both pullup or both pulldown.

#### 9.2.2.2.1 Enable Times

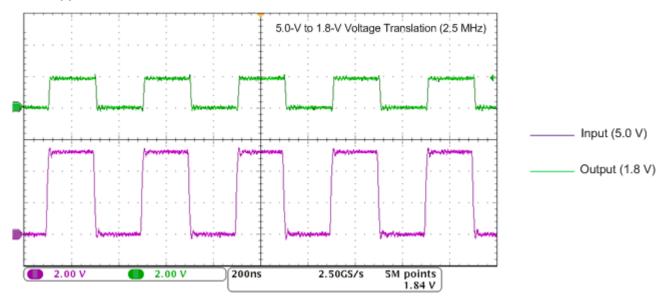
Calculate the enable times for the SN74LVC2T45 using the following formulas:

- $t_{PZH}$  (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A)
- $t_{PZL}$  (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A)
- $t_{PZH}$  (DIR to B) =  $t_{PLZ}$  (DIR to A) +  $t_{PLH}$  (A to B)
- $t_{PZL}$  (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74LVC2T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.



#### 9.2.2.3 Application Curve



### 10 Power Supply Recommendations

#### 10.1 Power-Up Considerations

A proper power-up sequence with inputs held at ground should be followed as listed:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up V<sub>CCA</sub>.
- 3.  $V_{CCB}$  can be ramped up along with or after  $V_{CCA}$ .

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions* table.

Each  $V_{CC}$  pin must have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1  $\mu F$  is recommended. If there are multiple  $V_{CC}$  pins, 0.01  $\mu F$  or 0.022  $\mu F$  is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1- $\mu F$  and 1- $\mu F$  are commonly used in parallel. The bypass capacitor must be installed as close to the power pin as possible for best results.

 $V_{CCA}$  $V_{CCB}$ UNIT 0 V 1.8 V 2.5 V 3.3 V 5 V 0 V 0 <1 <1 <1 <1 1.8 V <1 <2 <2 <2 2 2.5 V <1 <2 <2 <2 <2 μΑ 3.3 V <1 <2 <2 <2 <2 5 V <1 2 <2 <2 <2

Table 5. Typical Total Static Power Consumption (I<sub>CCA</sub> + I<sub>CCB</sub>)

## 11 Layout

#### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies.
- Short trace lengths should be used to avoid excessive loading.

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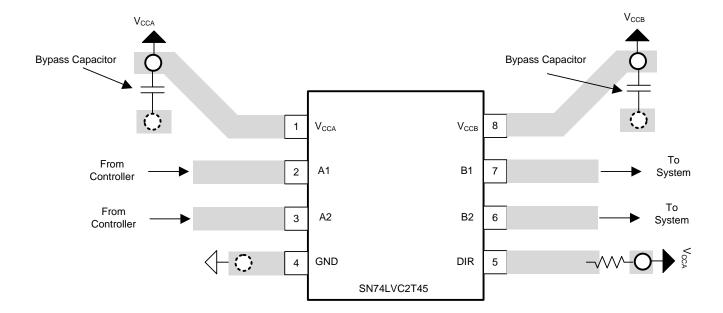


## **Layout Guidelines (continued)**

• Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements

### 11.2 Layout Example







## 12 Device and Documentation Support

#### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

Implications of Slow or Floating CMOS Inputs, SCBA004.

Designing with SN74LVCXT245 and SN74LVCHXT245 Family of Direction controlled voltage translators, SLVA746

#### 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.4 Trademarks

NanoFree, E2E are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

#### 12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### 12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





15-May-2017

#### **PACKAGING INFORMATION**

| Orderable Device  | Status (1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5)     | Samples |
|-------------------|------------|--------------|--------------------|------|----------------|----------------------------|-------------------|--------------------|--------------|--------------------------|---------|
| SN74LVC2T45DCTR   | ACTIVE     | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2<br>Z                 | Samples |
| SN74LVC2T45DCTRE4 | ACTIVE     | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2<br>Z                 | Samples |
| SN74LVC2T45DCTT   | ACTIVE     | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2<br>Z                 | Samples |
| SN74LVC2T45DCTTG4 | ACTIVE     | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2<br>Z                 | Samples |
| SN74LVC2T45DCUR   | ACTIVE     | VSSOP        | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN | Level-1-260C-UNLIM | -40 to 85    | (CT2Q ~ CT2R ~ T2)<br>CZ | Samples |
| SN74LVC2T45DCURE4 | ACTIVE     | VSSOP        | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2R                     | Samples |
| SN74LVC2T45DCURG4 | ACTIVE     | VSSOP        | DCU                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2R                     | Samples |
| SN74LVC2T45DCUT   | ACTIVE     | VSSOP        | DCU                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | (CT2Q ~ CT2R ~ T2)<br>CZ | Samples |
| SN74LVC2T45DCUTG4 | ACTIVE     | VSSOP        | DCU                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | CT2R                     | Samples |
| SN74LVC2T45YZPR   | ACTIVE     | DSBGA        | YZP                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | SNAGCU            | Level-1-260C-UNLIM | -40 to 85    | (TB ~ TB7 ~ TBN)         | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.





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- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN74LVC2T45:

Automotive: SN74LVC2T45-Q1

■ Enhanced Product: SN74LVC2T45-EP

#### NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications

# PACKAGE MATERIALS INFORMATION

www.ti.com 17-May-2018

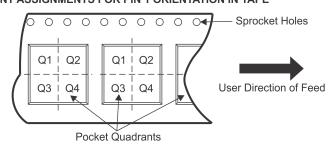
## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LVC2T45DCTR   | SM8             | DCT                | 8 | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| SN74LVC2T45DCTT   | SM8             | DCT                | 8 | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| SN74LVC2T45DCUR   | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 9.0                      | 2.05       | 3.3        | 1.0        | 4.0        | 8.0       | Q3               |
| SN74LVC2T45DCURG4 | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| SN74LVC2T45DCUTG4 | VSSOP           | DCU                | 8 | 250  | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| SN74LVC2T45YZPR   | DSBGA           | YZP                | 8 | 3000 | 180.0                    | 8.4                      | 1.02       | 2.02       | 0.63       | 4.0        | 8.0       | Q1               |
| SN74LVC2T45YZPR   | DSBGA           | YZP                | 8 | 3000 | 178.0                    | 9.2                      | 1.02       | 2.02       | 0.63       | 4.0        | 8.0       | Q1               |

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\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC2T45DCTR   | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74LVC2T45DCTT   | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| SN74LVC2T45DCUR   | VSSOP        | DCU             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74LVC2T45DCURG4 | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74LVC2T45DCUTG4 | VSSOP        | DCU             | 8    | 250  | 202.0       | 201.0      | 28.0        |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74LVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 220.0       | 220.0      | 35.0        |

## DCT (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

# DCT (R-PDSO-G8)

## PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





DIE SIZE BALL GRID ARRAY



#### NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.



DIE SIZE BALL GRID ARRAY



NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



# DCU (R-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES:

- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-187 variation CA.



DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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